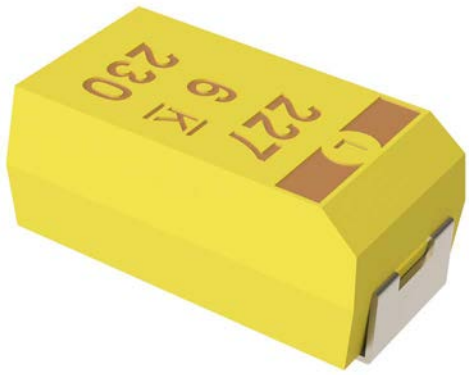
T489 Low DC Leakage MnO_2

Overview

The KEMET T489 provides DC leakage current that is 25% lower than the commercial T491. The T489 also offers improved reliability, low ESR options and meets or exceeds the requirements of EIA standard 535BAAC. The T489 is classified as moisture sensitivity level (MSL) 1 under J STD 020: unlimited floor life time at ≤ 30°C/85% RH. The T489 standard terminations are available in 100% matte tin and provide excellent wetting characteristics and compatibility with today's surface mount solder systems. Tin/lead (Sn/Pb) terminations are available upon request for any part number. Gold-plated terminations are also available for use with conductive epoxy attachment processes. Standard packaging of these devices is Tape & Reel in accordance with EIA 481. This system provides perfect compatibility with all tape-fed placement units.

Benefits

- DC Leakage at 0.0075 CV
- Improved reliability: 0.50%/1,000 hours, 85°C, rated voltage
- Low ESR options available
- Meets or exceeds EIA standard 535BAAC
- Taped and reeled per EIA 481
- Symmetrical, compliant terminations
- Laser-marked case
- Halogen-free epoxy
- Capacitance values of 0.1 µF to 470 µF
- Tolerances of ±10% and ±20%
- Voltage rating of 6.3 – 50 VDC
- RoHS compliant and lead-free terminations
- Operating temperature range of −55°C to +125°C



Applications

Typical applications include decoupling and filtering, in industrial and automotive high-end applications.

Environmental Compliance

RoHS compliant (6/6) according to Directive 2002/95/EC when ordered with 100% Sn solder or gold-plated.

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K-SIM

For a detailed analysis of specific part numbers, please visit ksim.kemet.com to access KEMET's K-SIM software. KEMET K-SIM is designed to simulate behavior of components with respect to frequency, ambient temperature, and DC bias levels.

Ordering Information

T	489	B	156	M	016	A	T	E800
Capacitor Class	Series	Case Size	Capacitance Code (pF)	Capacitance Tolerance	Rated Voltage (VDC)	Failure Rate/ Design	Termination Finish	ESR
T = Tantalum	Low DC Leakage Series	A B C D X	First two digits represent significant figures. Third digit specifies number of zeros.	K = ±10% M = ±20%	006 = 6.3 010 = 10 016 = 16 020 = 20 025 = 25 035 = 35 050 = 50	A = N/A	T = 100% Matte tin (Sn)-plated H = Standard solder coated (SnPb 5% Pb minimum) G = Gold-plated	E = ESR last three digits specify ESR in mOhms (800 = 800 mOhms)

Performance Characteristics

Item	Performance Characteristics
Operating Temperature	−55°C to 125°C
Rated Capacitance Range	0.10 to 470 µF at 120 Hz/25°C
Capacitance Tolerance	K Tolerance (±10%), M Tolerance (±20%)
Rated Voltage Range	6.3 – 50 V
DF(120 Hz)	Refer to Part Number Electrical Specification
ESR (100 kHz)	Refer to Part Number Electrical Specification
Leakage Current	≤ 0.0075 CV (µA) at rated voltage after 5 minutes
Reliability	0.50%/1,000 hours at 85°C, V_R with 0.1 Ω series resistance

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Qualification

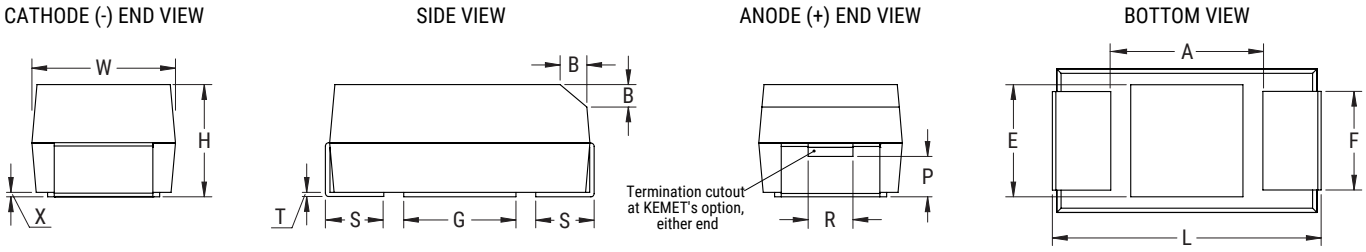
Test	Condition		Characteristics			
Endurance	85°C at rated voltage, 2,000 hours 125°C at 2/3 rated voltage, 2,000 hours		Δ C/C	Within ±10% of initial value		
			DF	Within initial limits		
			DCL	Within 1.25 x initial limit		
			ESR	Within initial limits		
Storage Life	125°C at 0 volts, 2,000 hours		Δ C/C	Within ±10% of initial value		
			DF	Within initial limits		
			DCL	Within 1.25 x initial limit		
			ESR	Within initial limits		
Thermal Shock	MIL–STD–202, Method 107, Condition B, mounted, –55C° to 125° C, 1,000 cycles		Δ C/C	Within ±5% of initial value		
			DF	Within initial limits		
			DCL	Within 1.25 x initial limit		
			ESR	Within initial limits		
Temperature Stability	Extreme temperature exposure at a succession of continuous steps at +25°C, –55°C, +25°C, +85°C, +125°C, +25°C			+25°C	–55°C	+85°C	+125°C
		Δ C/C		IL*	±10%	±10%	±20%
		DF		IL	IL	1.5 x IL	1.5 x IL
		DCL		IL	N/A	10 x IL	12 x IL
Surge Voltage	85°C, 1.32 x rated voltage 1,000 cycles (125°C, 1.2 x rated voltage)		Δ C/C	Within ±5% of initial value		
			DF	Within initial limits		
			DCL	Within initial limits		
			ESR	Within initial limits		
Mechanical Shock/ Vibration	MIL–STD–202, Method 213, Condition I, 100 G peak. MIL–STD–202, Method 204, Condition D, 10 Hz to 2,000 Hz, 20 G peak		Δ C/C	Within ±10% of initial value		
			DF	Within initial limits		
			DCL	Within initial limits		

**IL = Initial limit*

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Dimensions – Millimeters (Inches)

Metric will govern



Case Size		Component												
KEMET	EIA	L	W	H	F ±0.1 ±(0.004)	S ±0.3 ±(0.012)	B ±0.15 (Ref) ±0.006	X (Ref)	P (Ref)	R (Ref)	T (Ref)	A (Min)	G (Ref)	E (Ref)
A	3216–18	3.2±0.2 (0.126±0.008)	1.6±0.2 (0.063±0.008)	1.6±0.2 (0.063±0.008)	1.2 (0.047)	0.8 (0.031)	0.4 (0.016)	0.10±0.10 (0.004±0.004)	0.4 (0.016)	0.4 (0.016)	0.13 (0.005)	1.2 (0.047)	1.1 (0.043)	1.3 (0.051)
B	3528–21	3.5±0.2 (0.138±0.008)	2.8±0.2 (0.110±0.008)	1.9±0.2 (0.075±0.008)	2.2 (0.087)	0.8 (0.031)	0.4 (0.016)	0.10±0.10 (0.004±0.004)	0.5 (0.020)	1.0 (0.039)	0.13 (0.005)	1.9 (0.075)	1.8 (0.071)	2.2 (0.087)
C	6032–28	6.0±0.3 (0.236±0.012)	3.2±0.3 (0.126±0.012)	2.5±0.3 (0.098±0.012)	2.2 (0.087)	1.3 (0.051)	0.5 (0.020)	0.10±0.10 (0.004±0.004)	0.9 (0.035)	1.0 (0.039)	0.13 (0.005)	3.1 (0.122)	2.8 (0.110)	2.4 (0.094)
D	7343–31	7.3±0.3 (0.287±0.012)	4.3±0.3 (0.169±0.012)	2.8±0.3 (0.110±0.012)	2.4 (0.094)	1.3 (0.051)	0.5 (0.020)	0.10±0.10 (0.004±0.004)	0.9 (0.035)	1.0 (0.039)	0.13 (0.005)	3.8 (0.150)	3.5 (0.138)	3.5 (0.138)
X	7343–43	7.3±0.3 (0.287±0.012)	4.3±0.3 (0.169±0.012)	4.0±0.3 (0.157±0.012)	2.4 (0.094)	1.3 (0.051)	0.5 (0.020)	0.10±0.10 (0.004±0.004)	1.7 (0.067)	1.0 (0.039)	0.13 (0.005)	3.8 (0.150)	3.5 (0.138)	3.5 (0.138)

Notes: (Ref) – Dimensions provided for reference only.

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Table 1 – Ratings & Part Number Reference

Rated Voltage	Rated Capacitance	Case Code/ Case Size	KEMET Part Number	DC Leakage	DF	Standard ESR		Low ESR		Maximum Operating Temp
VDC at 85°C	µF	KEMET/EIA	(See below for part options)	µA at +25°C Maximum/ 5 Minutes	% at +25°C 120 Hz Maximum	mΩ at +25°C 100 kHz Maximum	E-Spec Code	mΩ at +25°C 100 kHz Maximum	E-Spec Code	°C
6.3	10	B/3528-21	T489B106(1)006A(2)	0.5	6.0	3000	E3K0			125
6.3	15	A/3216-18	T489A156(1)006A(2)	0.7	6.0	2030	E2K0	1500	E1K5	125
6.3	22	C/6032-28	T489C226(1)006A(2)	1.0	6.0	2000	E2K0			125
6.3	47	B/3528-21	T489B476(1)006A(2)	2.2	6.0	1620	E1K6	500	E500	125
6.3	150	B/3528-21	T489B157(1)006A(2)	7.1	15.0	3000	E3K0			125
6.3	100	C/6032-28	T489C107(1)006A(2)	4.7	6.0	440	E440			125
6.3	150	C/6032-28	T489C157(1)006A(2)	7.1	8.0	500	E500	300	E300	125
6.3	100	D/7343-31	T489D107(1)006A(2)	4.7	8.0	800	E800			125
6.3	150	D/7343-31	T489D157(1)006A(2)	7.1	6.0	400	E400	150	E150	125
6.3	220	D/7343-31	T489D227(1)006A(2)	10.4	8.0	360	E360	150	E150	125
6.3	470	X/7343-43	T489X477(1)006A(2)	22.2	8.0	250	E250	200	E200	125
6.3	680	X/7343-43	T489X687(1)006A(2)	32.1	15.0	600	E600			125
10	2.2	A/3216-18	T489A225(1)010A(2)	0.5	6.0	7000	E7K0			125
10	4.7	A/3216-18	T489A475(1)010A(2)	0.5	6.0	2900	E2K9			125
10	6.8	A/3216-18	T489A685(1)010A(2)	0.5	6.0	2650	E2K6			125
10	6.8	B/3528-21	T489B685(1)010A(2)	0.5	6.0	3000	E3K0			125
10	10	A/3216-18	T489A106(1)010A(2)	0.8	6.0	2200	E2K2	1800	E1K8	125
10	15	B/3528-21	T489B156(1)010A(2)	1.1	6.0	2030	E2K0			125
10	15	C/6032-28	T489C156(1)010A(2)	1.1	6.0	2000	E2K0			125
10	22	B/3528-21	T489B226(1)010A(2)	1.7	6.0	1880	E1K8	700	E700	125
10	33	B/3528-21	T489B336(1)010A(2)	2.5	6.0	1000	E1K0	650	E650	125
10	33	C/6032-28	T489C336(1)010A(2)	2.5	6.0	590	E590			125
10	33	D/7343-31	T489D336(1)010A(2)	2.5	6.0	1100	E1K1			125
10	47	C/6032-28	T489C476(1)010A(2)	3.5	6.0	540	E540			125
10	47	D/7343-31	T489D476(1)010A(2)	3.5	6.0	400	E400			125
10	68	C/6032-28	T489C686(1)010A(2)	5.1	6.0	490	E490			125
10	100	C/6032-28	T489C107(1)010A(2)	7.5	8.0	500	E500			125
10	100	D/7343-31	T489D107(1)010A(2)	7.5	6.0	440	E440	150	E150	125
10	150	D/7343-31	T489D157(1)010A(2)	11.3	8.0	400	E400	150	E150	125
10	220	D/7343-31	T489D227(1)010A(2)	16.5	8.0	500	E500			125
10	330	X/7343-43	T489X337(1)010A(2)	24.8	8.0	300	E300	100	E100	125
16	1	A/3216-18	T489A105(1)016A(2)	0.5	6.0	10000	E10K			125
16	2.2	A/3216-18	T489A225(1)016A(2)	0.5	6.0	4550	E4K5	3500	E3K5	125
16	3.3	B/3528-21	T489B335(1)016A(2)	0.5	6.0	4500	E4K5			125
16	4.7	B/3528-21	T489B475(1)016A(2)	0.6	6.0	3160	E3K1			125
16	6.8	B/3528-21	T489B685(1)016A(2)	0.8	6.0	2650	E2K6			125
16	6.8	C/6032-28	T489C685(1)016A(2)	0.8	6.0	2500	E2K5			125
16	10	B/3528-21	T489B106(1)016A(2)	1.2	6.0	2200	E2K2			125
16	10	C/6032-28	T489C106(1)016A(2)	1.2	6.0	2000	E2K0			125
16	15	B/3528-21	T489B156(1)016A(2)	1.8	6.0	2030	E2K0	800	E800	125
16	22	B/3528-21	T489B226(1)016A(2)	2.6	6.0	1100	E1K1	600	E600	125
16	22	C/6032-28	T489C226(1)016A(2)	2.6	6.0	700	E700	350	E350	125
16	22	D/7343-31	T489D226(1)016A(2)	2.6	6.0	1100	E1K1			125
16	33	C/6032-28	T489C336(1)016A(2)	4.0	6.0	590	E590			125
16	47	C/6032-28	T489C476(1)016A(2)	5.6	6.0	540	E540	350	E350	125
16	47	D/7343-31	T489D476(1)016A(2)	5.6	6.0	540	E540	200	E200	125
16	68	D/7343-31	T489D686(1)016A(2)	8.2	6.0	490	E490	150	E150	125
16	100	C/6032-28	T489C107(1)016A(2)	12.0	10.0	1000	E1K0			125
VDC at 85°C	µF	KEMET/EIA	(See below for part options)	µA at +25°C Maximum/ 5 Minutes	% at +25°C 120 Hz Maximum	mΩ at +25°C 100 kHz Maximum	E-Spec Code	mΩ at +25°C 100 kHz Maximum	E-Spec Code	°C
Rated Voltage	Rated Capacitance	Case Code/ Case Size	KEMET Part Number	DC Leakage	DF	Standard ESR		Low ESR		Maximum Operating Temp

(1) To complete KEMET part number, insert M for ±20% or K for ±10%. Designates Capacitance tolerance.
(2) To complete KEMET part number, insert T = 100% Matte Tin (Sn) Plated, G = Gold Plated, H = Standard Solder coated (SnPb 5% Pb minimum). Designates Termination Finish.
Refer to Ordering Information for additional detail.
Higher voltage ratings and tighter tolerance product including ESR may be substituted within the same size at KEMET's option. Voltage substitution will be marked with the higher voltage rating. Substitutions can include better than series.

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Table 1 – Ratings & Part Number Reference cont'd

Rated Voltage	Rated Capacitance	Case Code/ Case Size	KEMET Part Number	DC Leakage	DF	Standard ESR		Low ESR		Maximum Operating Temp
VDC at 85°C	µF	KEMET/EIA	(See below for part options)	µA at +25°C Maximum/ 5 Minutes	% at +25°C 120 Hz Maximum	mΩ at +25°C 100 kHz Maximum	E-Spec Code	mΩ at +25°C 100 kHz Maximum	E-Spec Code	°C
16	100	D/7343-31	T489D107(1)016A(2)	12.0	6.0	440	E440	150	E150	125
16	150	D/7343-31	T489D157(1)016A(2)	18.0	12.0	700	E700			125
20	1	A/3216-18	T489A105(1)020A(2)	0.5	4.0	6630	E6K6			125
20	1.5	A/3216-18	T489A155(1)020A(2)	0.5	6.0	5460	E5K4			125
20	2.2	A/3216-18	T489A225(1)020A(2)	0.5	6.0	4550	E4K5			125
20	3.3	A/3216-18	T489A335(1)020A(2)	0.5	6.0	3740	E3K7	3500	E3K5	125
20	3.3	B/3528-21	T489B335(1)020A(2)	0.5	6.0	3740	E3K7			125
20	4.7	B/3528-21	T489B475(1)020A(2)	0.7	6.0	3160	E3K1			125
20	6.8	B/3528-21	T489B685(1)020A(2)	1.0	6.0	2650	E2K6			125
20	6.8	C/6032-28	T489C685(1)020A(2)	1.0	6.0	2000	E2K0			125
20	10	B/3528-21	T489B106(1)020A(2)	1.5	6.0	2200	E2K2	1000	E1K0	125
20	10	C/6032-28	T489C106(1)020A(2)	1.5	6.0	800	E800	500	E500	125
20	15	C/6032-28	T489C156(1)020A(2)	2.3	6.0	720	E720	400	E400	125
20	15	D/7343-31	T489D156(1)020A(2)	2.3	6.0	1100	E1K1			125
20	22	D/7343-31	T489D226(1)020A(2)	3.3	6.0	650	E650	300	E300	125
20	33	C/6032-28	T489C336(1)020A(2)	5.0	6.0	590	E590	300	E300	125
20	33	D/7343-31	T489D336(1)020A(2)	5.0	6.0	590	E590	250	E250	125
20	47	D/7343-31	T489D476(1)020A(2)	7.1	6.0	540	E540	200	E200	125
20	68	C/6032-28	T489C686(1)020A(2)	10.2	8.0	500	E500			125
20	68	D/7343-31	T489D686(1)020A(2)	10.2	6.0	490	E490	200	E200	125
20	100	X/7343-43	T489X107(1)020A(2)	15.0	6.0	300	E300	150	E150	125
25	0.47	A/3216-18	T489A474(1)025A(2)	0.5	4.0	9530	E9K5	7000	E7K0	125
25	0.68	A/3216-18	T489A684(1)025A(2)	0.5	4.0	7980	E7K9			125
25	1	A/3216-18	T489A105(1)025A(2)	0.5	4.0	6630	E6K6			125
25	2.2	B/3528-21	T489B225(1)025A(2)	0.5	6.0	4550	E4K5			125
25	3.3	B/3528-21	T489B335(1)025A(2)	0.6	6.0	3740	E3K7	2000	E2K0	125
25	4.7	B/3528-21	T489B475(1)025A(2)	0.9	6.0	3160	E3K1	1000	E1K0	125
25	6.8	B/3528-21	T489B685(1)025A(2)	1.3	6.0	1500	E1K5	1000	E1K0	125
25	6.8	C/6032-28	T489C685(1)025A(2)	1.3	6.0	1070	E1K0	600	E600	125
25	10	C/6032-28	T489C106(1)025A(2)	1.9	6.0	800	E800	600	E600	125
25	10	D/7343-31	T489D106(1)025A(2)	1.9	6.0	1200	E1K2			125
25	15	C/6032-28	T489C156(1)025A(2)	2.8	6.0	720	E720			125
25	15	D/7343-31	T489D156(1)025A(2)	2.8	6.0	720	E720	300	E300	125
25	22	D/7343-31	T489D226(1)025A(2)	4.1	6.0	650	E650	300	E300	125
25	33	D/7343-31	T489D336(1)025A(2)	6.2	6.0	590	E590	400	E400	125
25	47	D/7343-31	T489D476(1)025A(2)	8.8	6.0	540	E540	250	E250	125
35	0.1	A/3216-18	T489A104(1)035A(2)	0.5	4.0	20000	E20K			125
35	0.22	A/3216-18	T489A224(1)035A(2)	0.5	4.0	13710	E13K			125
35	0.33	A/3216-18	T489A334(1)035A(2)	0.5	4.0	11280	E11K			125
35	1	A/3216-18	T489A105(1)035A(2)	0.5	4.0	6630	E6K6	3000	E3K0	125
35	1	B/3528-21	T489B105(1)035A(2)	0.5	4.0	3400	E3K4	2000	E2K0	125
35	1.5	B/3528-21	T489B155(1)035A(2)	0.5	6.0	5460	E5K4	2500	E2K5	125
35	2.2	B/3528-21	T489B225(1)035A(2)	0.6	6.0	4550	E4K5	2000	E2K0	125
35	3.3	B/3528-21	T489B335(1)035A(2)	0.9	6.0	3740	E3K7			125
35	3.3	C/6032-28	T489C335(1)035A(2)	0.9	6.0	1840	E1K8	800	E800	125
35	4.7	C/6032-28	T489C475(1)035A(2)	1.2	6.0	1410	E1K4	600	E600	125
35	4.7	D/7343-31	T489D475(1)035A(2)	1.2	6.0	1500	E1K5			125
35	6.8	C/6032-28	T489C685(1)035A(2)	1.8	6.0	1070	E1K0	600	E600	125
VDC at 85°C	µF	KEMET/EIA	(See below for part options)	µA at +25°C Maximum/ 5 Minutes	% at +25°C 120 Hz Maximum	mΩ at +25°C 100 kHz Maximum	E-Spec Code	mΩ at +25°C 100 kHz Maximum	E-Spec Code	°C
Rated Voltage	Rated Capacitance	Case Code/ Case Size	KEMET Part Number	DC Leakage	DF	Standard ESR		Low ESR		Maximum Operating Temp

(1) To complete KEMET part number, insert M for ±20% or K for ±10%. Designates Capacitance tolerance.
(2) To complete KEMET part number, insert T = 100% Matte Tin (Sn) Plated, G = Gold Plated, H = Standard Solder coated (SnPb 5% Pb minimum). Designates Termination Finish.
Refer to Ordering Information for additional detail.
Higher voltage ratings and tighter tolerance product including ESR may be substituted within the same size at KEMET's option. Voltage substitution will be marked with the higher voltage rating. Substitutions can include better than series.

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Table 1 – Ratings & Part Number Reference cont'd

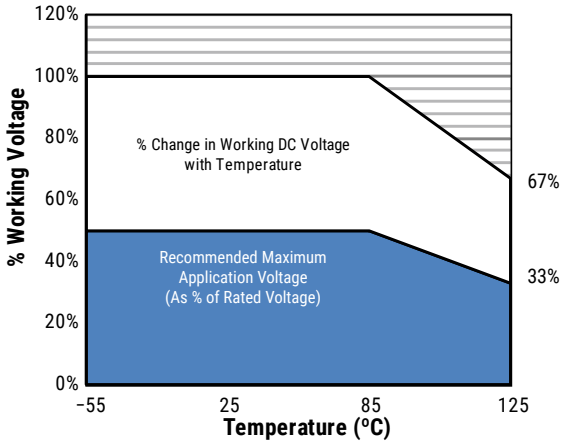
Rated Voltage	Rated Capacitance	Case Code/ Case Size	KEMET Part Number	DC Leakage	DF	Standard ESR		Low ESR		Maximum Operating Temp
VDC at 85°C	µF	KEMET/EIA	(See below for part options)	µA at +25°C Maximum/ 5 Minutes	% at +25°C 120 Hz Maximum	mΩ at +25°C 100 kHz Maximum	E-Spec Code	mΩ at +25°C 100 kHz Maximum	E-Spec Code	°C
35	6.8	D/7343-31	T489D685(1)035A(2)	1.8	6.0	1300	E1K3			125
35	10	C/6032-28	T489C106(1)035A(2)	2.6	6.0	800	E800	600	E600	125
35	10	D/7343-31	T489D106(1)035A(2)	2.6	6.0	800	E800	400	E400	125
35	15	D/7343-31	T489D156(1)035A(2)	3.9	6.0	720	E720	350	E350	125
35	22	D/7343-31	T489D226(1)035A(2)	5.8	6.0	650	E650	300	E300	125
50	0.22	A/3216-18	T489A224(1)050A(2)	0.5	4.0	7500	E7K5	7000	E7K0	125
50	0.33	A/3216-18	T489A334(1)050A(2)	0.5	4.0	7000	E7K0			125
50	0.68	B/3528-21	T489B684(1)050A(2)	0.5	4.0	4000	E4K0	2000	E2K0	125
50	1	C/6032-28	T489C105(1)050A(2)	0.5	4.0	3000	E3K0			125
50	1.5	C/6032-28	T489C155(1)050A(2)	0.6	6.0	2500	E2K5	1500	E1K5	125
50	2.2	C/6032-28	T489C225(1)050A(2)	0.8	6.0	1700	E1K7	1000	E1K0	125
50	2.2	D/7343-31	T489D225(1)050A(2)	0.8	4.5	2000	E2K0	1200	E1K2	125
50	3.3	D/7343-31	T489D335(1)050A(2)	1.2	4.5	1100	E1K1	800	E800	125
50	4.7	D/7343-31	T489D475(1)050A(2)	1.8	4.5	900	E900	600	E600	125
50	6.8	D/7343-31	T489D685(1)050A(2)	2.6	4.5	700	E700			125
VDC at 85°C	µF	KEMET/EIA	(See below for part options)	µA at +25°C Maximum/ 5 Minutes	% at +25°C 120 Hz Maximum	mΩ at +25°C 100 kHz Maximum	E-Spec Code	mΩ at +25°C 100 kHz Maximum	E-Spec Code	°C
Rated Voltage	Rated Capacitance	Case Code/ Case Size	KEMET Part Number	DC Leakage	DF	Standard ESR		Low ESR		Maximum Operating Temp

(1) To complete KEMET part number, insert M for ±20% or K for ±10%. Designates Capacitance tolerance.
(2) To complete KEMET part number, insert T = 100% Matte Tin (Sn) Plated, G = Gold Plated, H = Standard Solder coated (SnPb 5% Pb minimum). Designates Termination Finish.
Refer to Ordering Information for additional detail.
Higher voltage ratings and tighter tolerance product including ESR may be substituted within the same size at KEMET's option. Voltage substitution will be marked with the higher voltage rating. Substitutions can include better than series.

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Recommended Voltage Derating Guidelines

	−55°C to 85°C	85°C to 125°C
% Change in working DC voltage with temperature	V_R	67% of V_R
Recommended maximum application voltage	50% of V_R	33% of V_R



Ripple Current/Ripple Voltage

KEMET Series and Case Code	EIA Case Code	Maximum Power Dissipation (P max) mWatts at 25°C with +20°C Rise
A	3216–18	75
B	3528–21	85
C	6032–28	110
D	7343–31	150
X	7343–43	165
E	7360–38	200
S	3216–12	60
T	3528–12	70
U	6032–15	90
V	7343–20	125
T510X	7343–43	270
T510E	7360–38	285

Temperature Compensation Multipliers for Maximum Ripple Current		
T ≤ 25°C	T ≤ 85°C	T ≤ 125°C
1.00	0.90	0.40

T= Environmental Temperature

Using the P max of the device, the maximum allowable rms ripple current or voltage may be determined.

$I(max) = \sqrt{P\ max/R}$
$E(max) = Z\sqrt{P\ max/R}$

I = rms ripple current (amperes)
E = rms ripple voltage (volts)
Pmax = maximum power dissipation (watts)
R = ESR at specified frequency (ohms)
Z = Impedance at specified frequency (ohms)

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Reverse Voltage

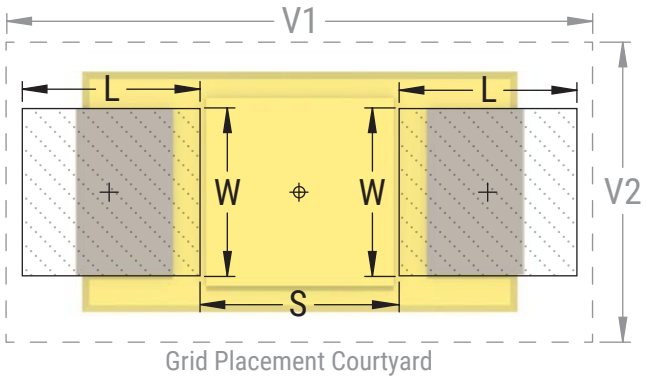
Solid tantalum capacitors are polar devices and may be permanently damaged or destroyed if connected with the wrong polarity. The positive terminal is identified on the capacitor body by a stripe plus in some cases a beveled edge. A small degree of transient reverse voltage is permissible for short periods per the table. The capacitors should not be operated continuously in reverse mode, even within these limits.

Temperature	Permissible Transient Reverse Voltage
25°C	15% of Rated Voltage
85°C	5% of Rated Voltage
125°C	1% of Rated Voltage

Table 2 – Land Dimensions/Courtyard

KEMET	Metric Size Code	Density Level A: Maximum (Most) Land Protrusion (mm)					Density Level B: Median (Nominal) Land Protrusion (mm)					Density Level C: Minimum (Least) Land Protrusion (mm)				
Case	EIA	W	L	S	V1	V2	W	L	S	V1	V2	W	L	S	V1	V2
A	3216–18	1.35	2.20	0.62	6.02	2.80	1.23	1.80	0.82	4.92	2.30	1.13	1.42	0.98	4.06	2.04
B	3528–21	2.35	2.21	0.92	6.32	4.00	2.23	1.80	1.12	5.22	3.50	2.13	1.42	1.28	4.36	3.24
C	6032–28	2.35	2.77	2.37	8.92	4.50	2.23	2.37	2.57	7.82	4.00	2.13	1.99	2.73	6.96	3.74
D	7343–31	2.55	2.77	3.67	10.22	5.60	2.43	2.37	3.87	9.12	5.10	2.33	1.99	4.03	8.26	4.84
X[1]	7343–43	2.55	2.77	3.67	10.22	5.60	2.43	2.37	3.87	9.12	5.10	2.33	1.99	4.03	8.26	4.84

Density Level A: *For low-density product applications. Recommended for wave solder applications and provides a wider process window for reflow solder processes.*
Density Level B: *For products with a moderate level of component density. Provides a robust solder attachment condition for reflow solder processes.*
Density Level C: *For high component density product applications. Before adapting the minimum land pattern variations the user should perform qualification testing based on the conditions outlined in IPC standard 7351 (IPC–7351).*
[1] *Height of these chips may create problems in wave soldering.*
[2] *Land pattern geometry is too small for silkscreen outline.*



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Soldering Process

The KEMET families of surface mount capacitors are compatible with wave (single or dual), convection, IR, or vapor phase reflow techniques. Preheating of these components is recommended to avoid extreme thermal stress. KEMET's recommended profile conditions for convection and IR reflow reflect the profile conditions of the IPC/J–STD–020D standard for moisture sensitivity testing. The devices can safely withstand a maximum of three reflow passes at these conditions.

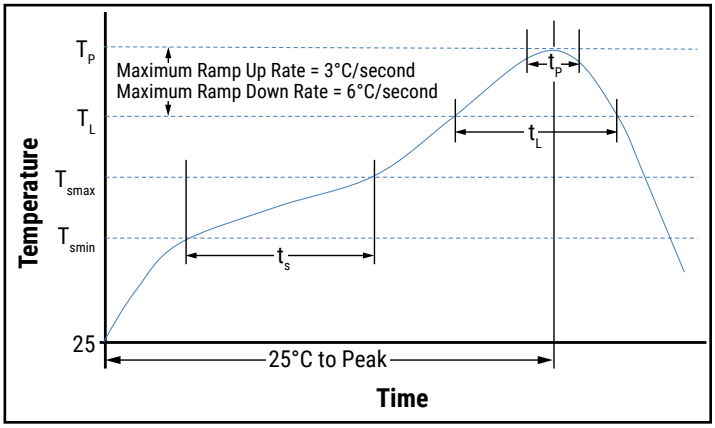
Please note that although the X/7343–43 case size can withstand wave soldering, the tall profile (4.3 mm maximum) dictates care in wave process development.

Hand soldering should be performed with care due to the difficulty in process control. If performed, care should be taken to avoid contact of the soldering iron to the molded case. The iron should be used to heat the solder pad, applying solder between the pad and the termination, until reflow occurs. Once reflow occurs, the iron should be removed immediately. “Wiping” the edges of a chip and heating the top surface is not recommended.

During typical reflow operations, a slight darkening of the gold-colored epoxy may be observed. This slight darkening is normal and not harmful to the product. Marking permanency is not affected by this change.

Profile Feature	SnPb Assembly	Pb-Free Assembly
Preheat/Soak		
Temperature Minimum (T_{Smin})	100°C	150°C
Temperature Maximum (T_{Smax})	150°C	200°C
Time (t_s) from T_{smin} to T_{smax})	60 – 120 seconds	60 – 120 seconds
Ramp-up Rate (T_L to T_P)	3°C/second maximum	3°C/second maximum
Liquidous Temperature (T_L)	183°C	217°C
Time Above Liquidous (t_L)	60 – 150 seconds	60 – 150 seconds
Peak Temperature (T_P)	220°C* 235°C**	250°C* 260°C**
Time within 5°C of Maximum Peak Temperature (t_P)	20 seconds maximum	30 seconds maximum
Ramp-down Rate (T_P to T_L)	6°C/second maximum	6°C/second maximum
Time 25°C to Peak Temperature	6 minutes maximum	8 minutes maximum

Note: All temperatures refer to the center of the package, measured on the package body surface that is facing up during assembly reflow.
** For Case Size height > 2.5 mm*
*** For Case Size height ≤ 2.5 mm*

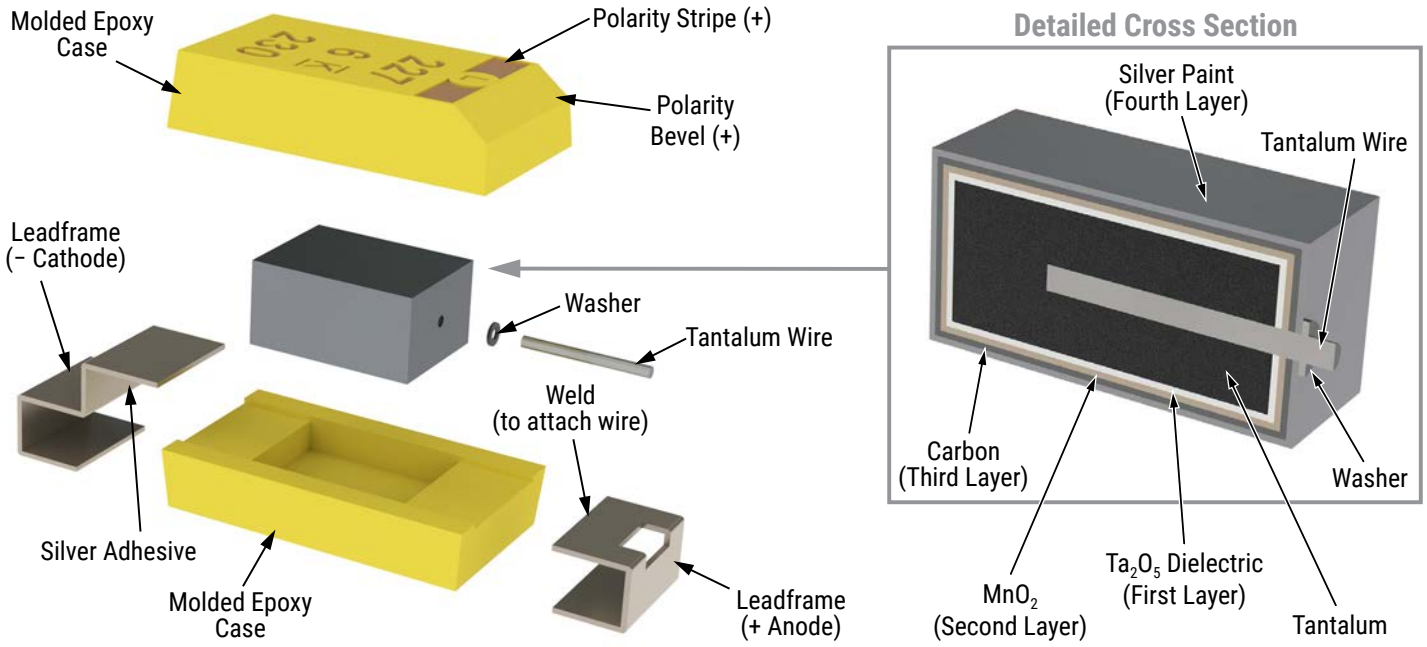


Storage

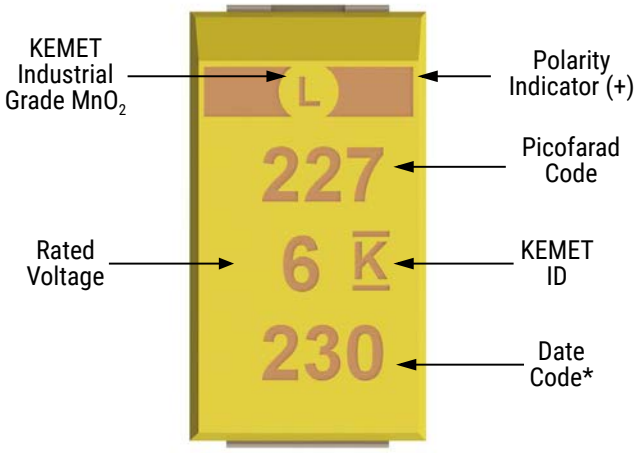
Tantalum chip capacitors should be stored in normal working environments. While the chips themselves are quite robust in other environments, solderability will be degraded by exposure to high temperatures, high humidity, corrosive atmospheres, and long term storage. In addition, packaging materials will be degraded by high temperature – reels may soften or warp and tape peel force may increase. KEMET recommends that maximum storage temperature not exceed 40°C and maximum storage humidity not exceed 60% relative humidity. Temperature fluctuations should be minimized to avoid condensation on the parts and atmospheres should be free of chlorine and sulphur bearing compounds. For optimized solderability, chip stock should be used promptly, preferably within three years of receipt.

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Construction



Capacitor Marking



* 230 = 30th week of 2012

Date Code *	
1st digit = last number of year	2 = 2012 3 = 2013 4 = 2014 5 = 2015 6 = 2016 7 = 2017
2nd and 3rd digit = week of the year	01 = 1st week of the year to 52 = 52nd week of the year

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Tape & Reel Packaging Information

KEMET's molded chip capacitor families are packaged in 8 and 12 mm plastic tape on 7" and 13" reels in accordance with *EIA Standard 481*: Embossed Carrier Taping of Surface Mount Components for Automatic Handling. This packaging system is compatible with all tape-fed automatic pick-and-place systems.

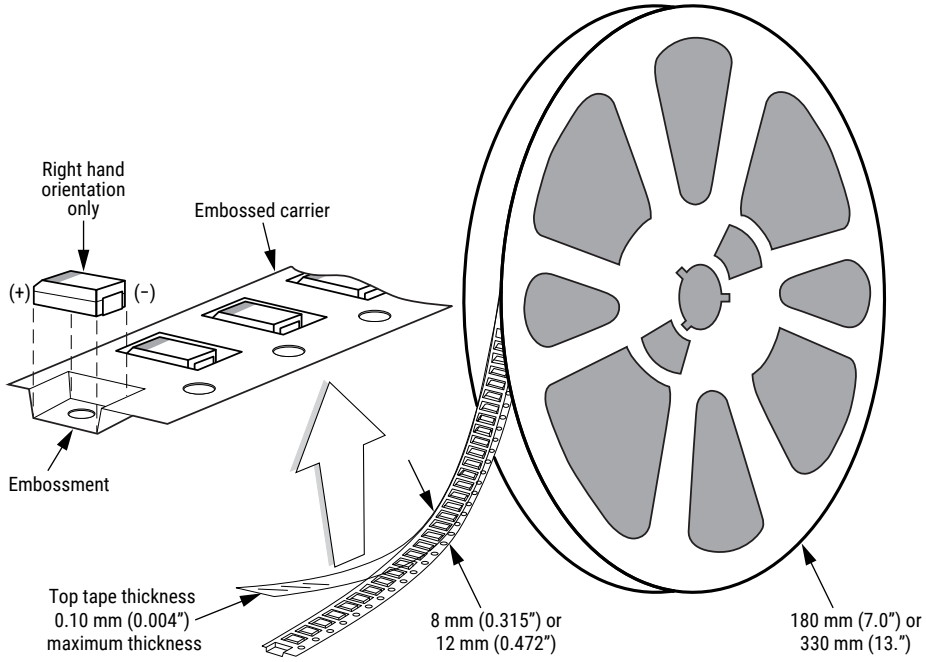


Table 3 – Packaging Quantity

Case Code		Tape Width (mm)	7" Reel*	13" Reel*
KEMET	EIA			
S	3216-12	8	2,500	10,000
T	3528-12	8	3,000	10,000
M	3528-15	8	2,500	8,000
U	6032-15	12	1,000	5,000
L	6032-19	12	1,000	3,000
W	7343-15	12	1,000	3,000
Z	7343-17	12	1,000	3,000
V	7343-20	12	1,000	3,000
A	3216-18	8	2,000	–
B	3528-21	8	2,000	8,000
C	6032-28	12	500	3,000
D	7343-31	12	500	2,500
Q	7343-12	12	1,000	3,000
Y	7343-40	12	500	2,000
X	7343-43	12	500	2,000
E/T428P	7360-38	12	500	2,000
H	7360-20	12	1,000	2,500
O	7360-43	12	250	1,000

** No C-Spec required for 7" reel packaging. C-7280 required for 13" reel packaging.*

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Figure 1 – Embossed (Plastic) Carrier Tape Dimensions

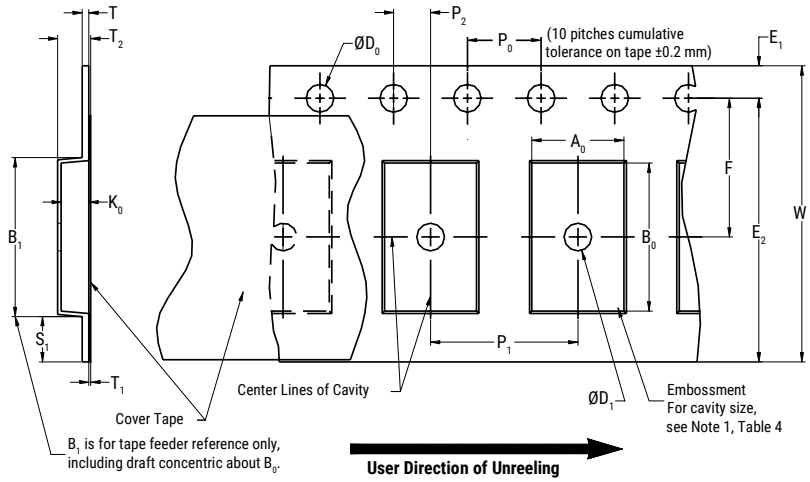


Table 4 – Embossed (Plastic) Carrier Tape Dimensions

Metric will govern

Constant Dimensions — Millimeters (Inches)									
Tape Size	D_0	D_1 Minimum Note 1	E_1	P_0	P_2	R Reference Note 2	S_1 Minimum Note 3	T Maximum	T_1 Maximum
8 mm	1.5 + 0.10/−0.0 (0.059 +0.004/−0.0)	1.0 (0.039)	1.75 ±0.10 (0.069 ±0.004)	4.0 ±0.10 (0.157 ±0.004)	2.0 ±0.05 (0.079 ±0.002)	25.0 (0.984)	0.600 (0.024)	0.600 (0.024)	0.100 (0.004)
12 mm		1.5 (0.059)				30 (1.181)			

Variable Dimensions — Millimeters (Inches)								
Tape Size	Pitch	B_1 Maximum Note 4	E_2 Minimum	F	P_1	T_2 Maximum	W Maximum	A_0, B_0 & K_0
8 mm	Single (4 mm)	4.35 (0.171)	6.25 (0.246)	3.5 ±0.05 (0.138 ±0.002)	2.0 ±0.05 or 4.0 ±0.10 (0.079 ±0.002 or 0.157 ±0.004)	2.5 (0.098)	8.3 (0.327)	Note 5
12 mm	Single (4 mm) and Double (8 mm)	8.2 (0.323)	10.25 (0.404)	5.5 ±0.05 (0.217 ±0.002)	2.0 ±0.05 (0.079 ±0.002) or 4.0 ±0.10 (0.157 ±0.004) or 8.0 ±0.10 (0.315 ±0.004)	4.6 (0.181)	12.3 (0.484)	

1. The embossment hole location shall be measured from the sprocket hole controlling the location of the embossment. Dimensions of embossment location and hole location shall be applied independent of each other.

2. The tape, with or without components, shall pass around R without damage (see Figure 4).

3. If S_1 < 1.0 mm, there may not be enough area for cover tape to be properly applied (see EIA Standard 481–D, paragraph 4.3, section b).

4. B_1 dimension is a reference dimension for tape feeder clearance only.

5. The cavity defined by A_0, B_0 and K_0 shall surround the component with sufficient clearance that:

(a) the component does not protrude above the top surface of the carrier tape.

(b) the component can be removed from the cavity in a vertical direction without mechanical restriction, after the top cover tape has been removed.

(c) rotation of the component is limited to 20° maximum for 8 and 12 mm tapes (see Figure 2).

(d) lateral movement of the component is restricted to 0.5 mm maximum for 8 mm and 12 mm wide tape (see Figure 3).

(e) see Addendum in EIA Standard 481–D for standards relating to more precise taping requirements.

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Packaging Information Performance Notes

1. Cover tape break force: 1.0 kg minimum.
2. Cover tape peel strength: The total peel strength of the cover tape from the carrier tape shall be:

Tape Width	Peel Strength
8 mm	0.1 to 1.0 newton (10 to 100 gf)
12 mm	0.1 to 1.3 newton (10 to 130 gf)

The direction of the pull shall be opposite the direction of the carrier tape travel. The pull angle of the carrier tape shall be 165° to 180° from the plane of the carrier tape. During peeling, the carrier and/or cover tape shall be pulled at a velocity of 300 ±10 mm/minute.
3. Labeling: Bar code labeling (standard or custom) shall be on the side of the reel opposite the sprocket holes. *Refer to EIA Standards 556 and 624*.

Figure 2 – Maximum Component Rotation

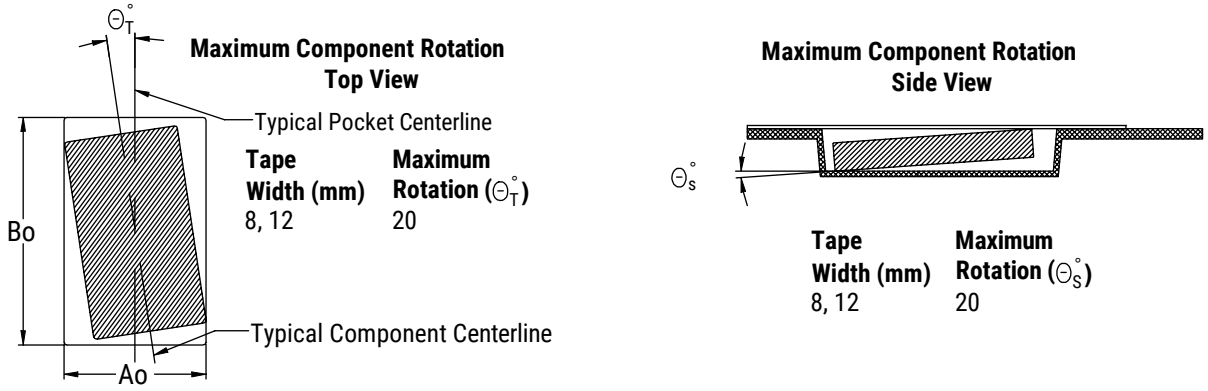


Figure 3 – Maximum Lateral Movement

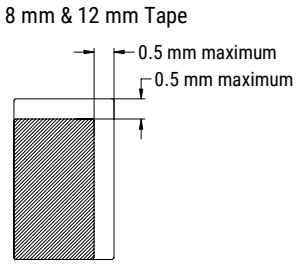
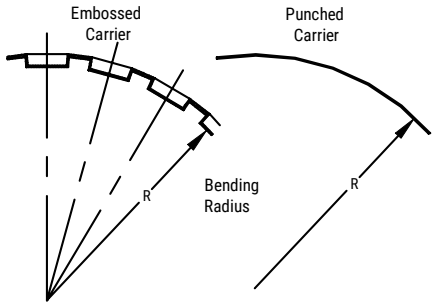
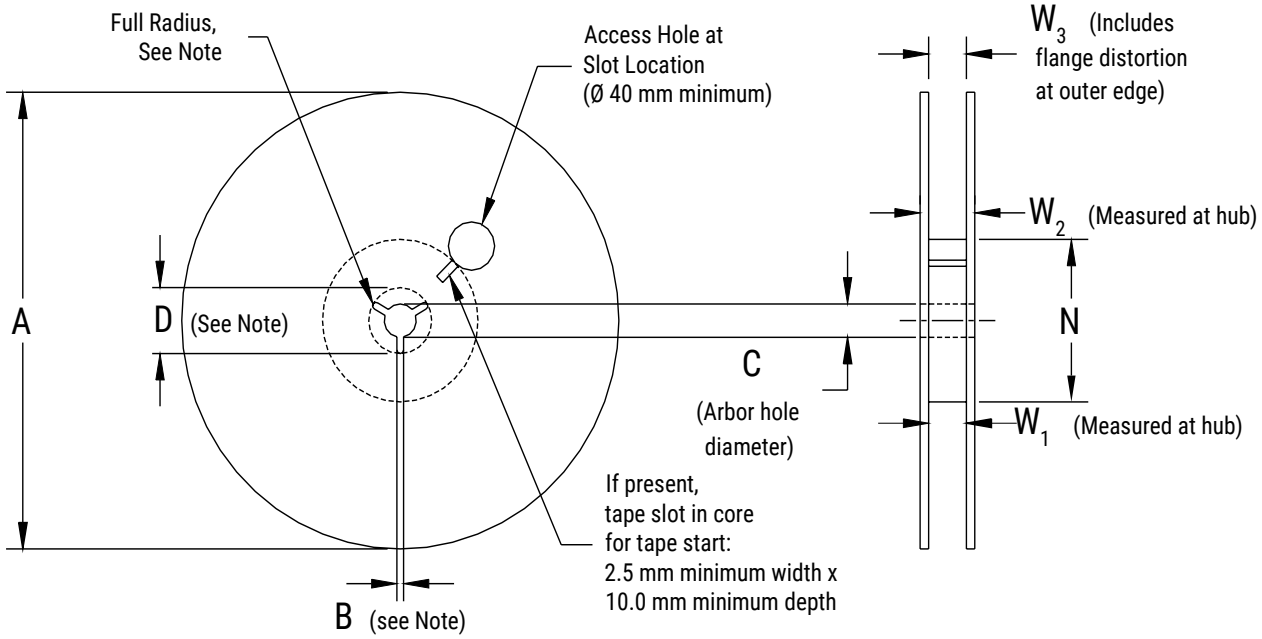


Figure 4 – Bending Radius



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Figure 5 – Reel Dimensions



Note: Drive spokes optional; if used, dimensions B and D shall apply.

Table 5 – Reel Dimensions

Metric will govern

Constant Dimensions — Millimeters (Inches)				
Tape Size	A	B Minimum	C	D Minimum
8 mm	178 ±0.20 (7.008 ±0.008) or 330 ±0.20 (13.000 ±0.008)	1.5 (0.059)	13.0 +0.5/−0.2 (0.521 +0.02/−0.008)	20.2 (0.795)
12 mm				

Variable Dimensions — Millimeters (Inches)				
Tape Size	N Minimum	W_1	W_2 Maximum	W_3
8 mm	50 (1.969)	8.4 +1.5/−0.0 (0.331 +0.059/−0.0)	14.4 (0.567)	Shall accommodate tape width without interference
12 mm		12.4 +2.0/−0.0 (0.488 +0.078/−0.0)	18.4 (0.724)	

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Figure 6 – Tape Leader & Trailer Dimensions

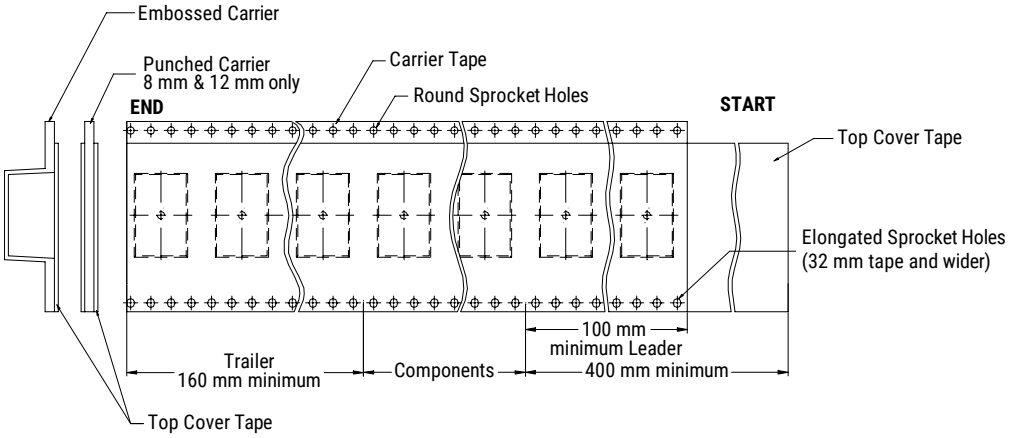
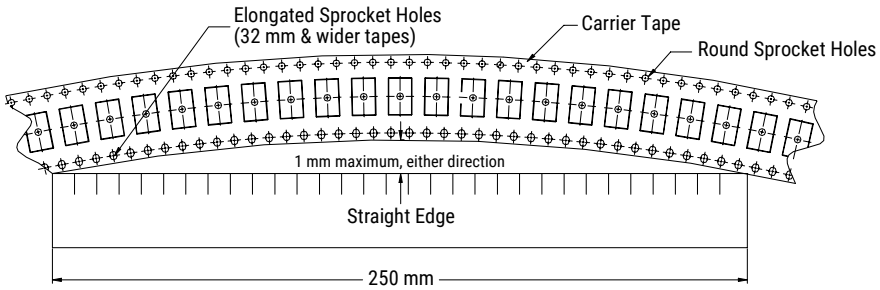


Figure 7 – Maximum Camber



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